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(12) **United States Design Patent**
Xun et al.

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(54) **EARPHONE**
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(**) Term: **15 Years**

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(21) Appl. No.: **35/512,044**

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(80) **Hague Agreement Data**

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(30) **Foreign Application Priority Data**

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(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/192, 205, 206, 223, 372; D24/106, D24/174; D13/107–110, 118
CPC G10K 11/1781; G10K 2210/1081; H04R 2420/07; H04R 1/083; H04M 1/6066
See application file for complete search history.

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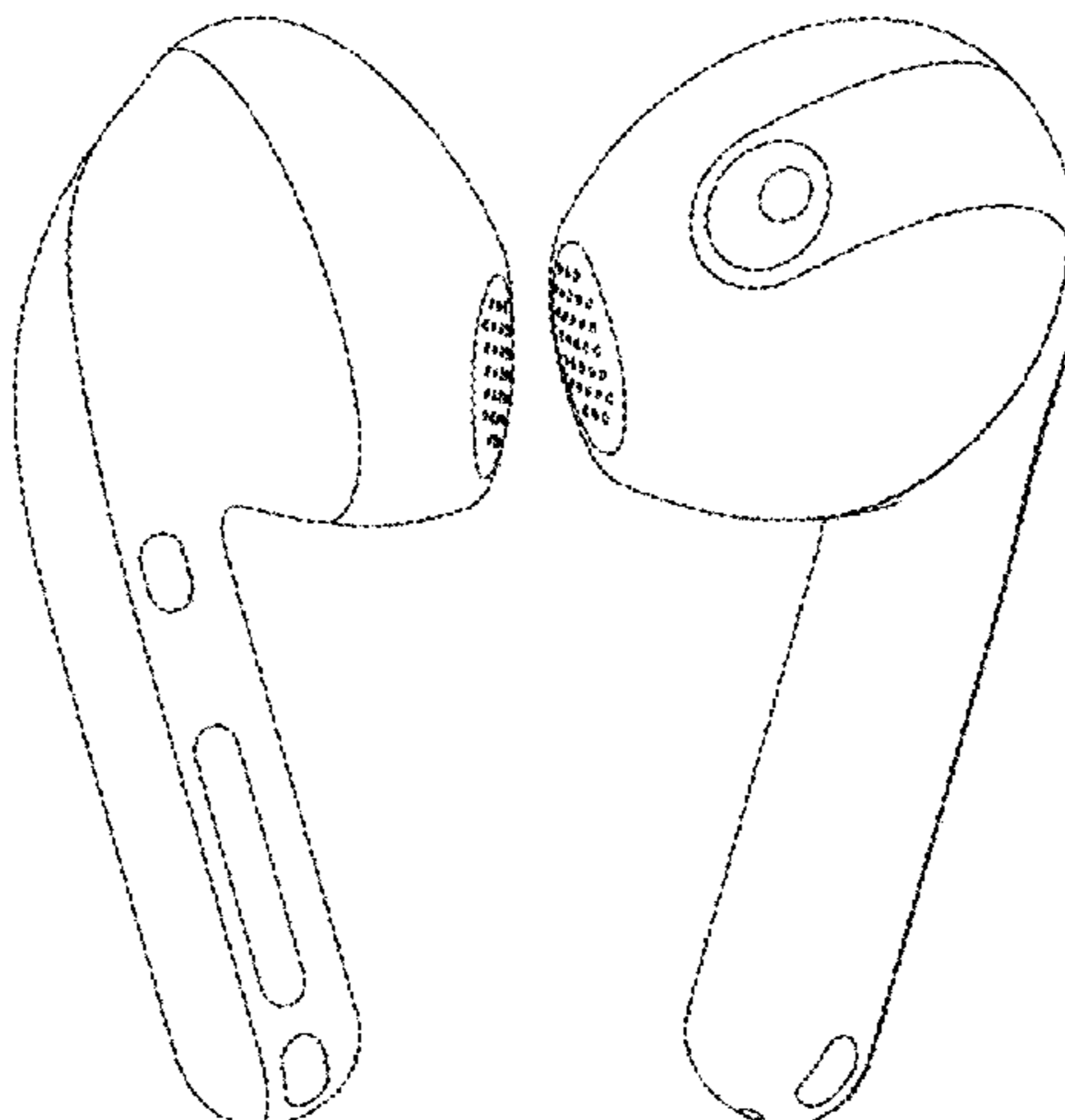
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

1. Earphone
1.1 is a front elevation view of an earphone showing our new design;
1.2 is a back elevation view thereof;
1.3 is a left side elevation view thereof;
1.4 is a right side elevation view thereof;
1.5 is a top plan view thereof;
1.6 is a bottom plan view thereof;
1.7 is a front, right side perspective view thereof; and
1.8 is a back, left side perspective view thereof.

1 Claim, 8 Drawing Sheets



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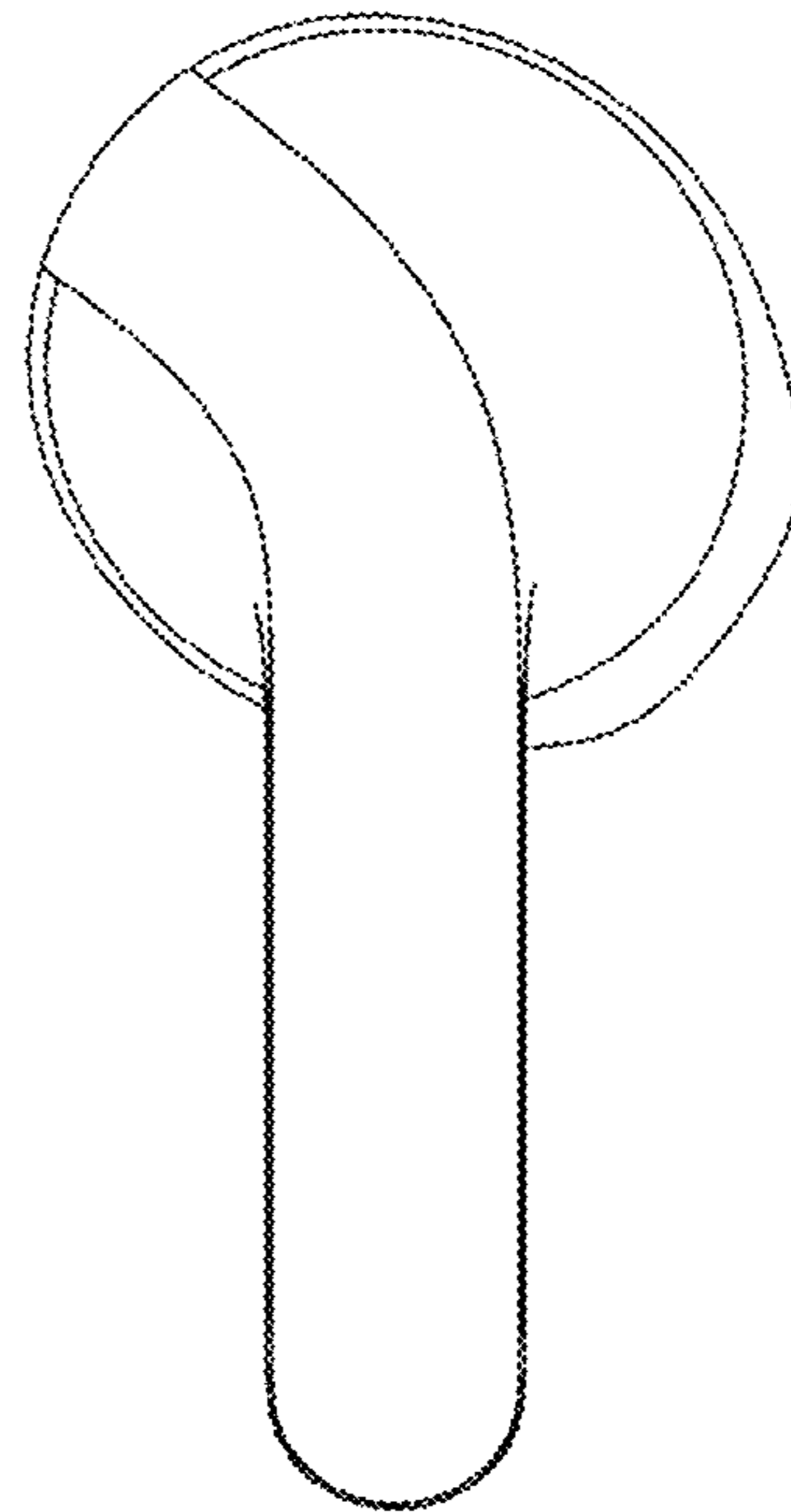
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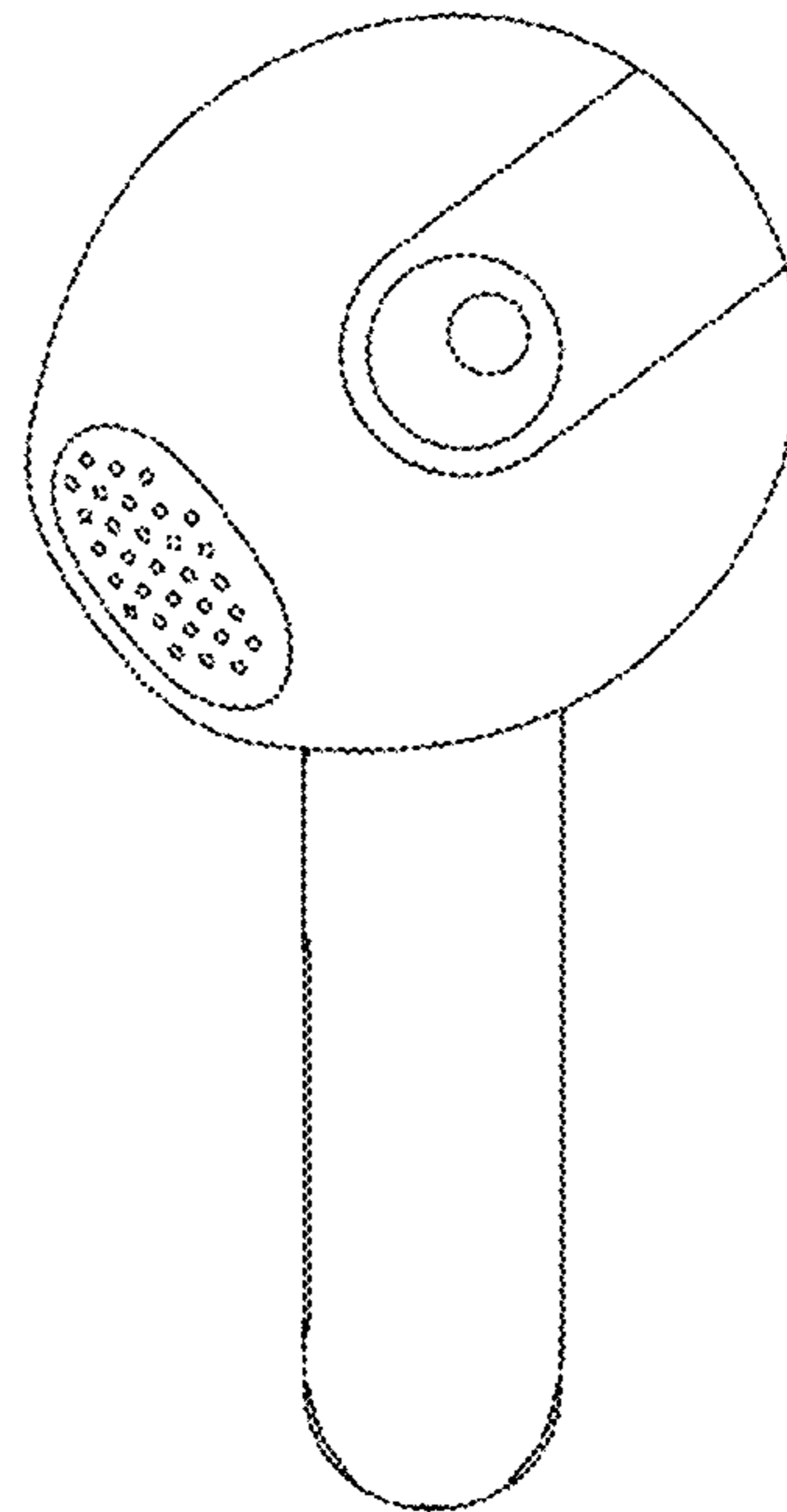
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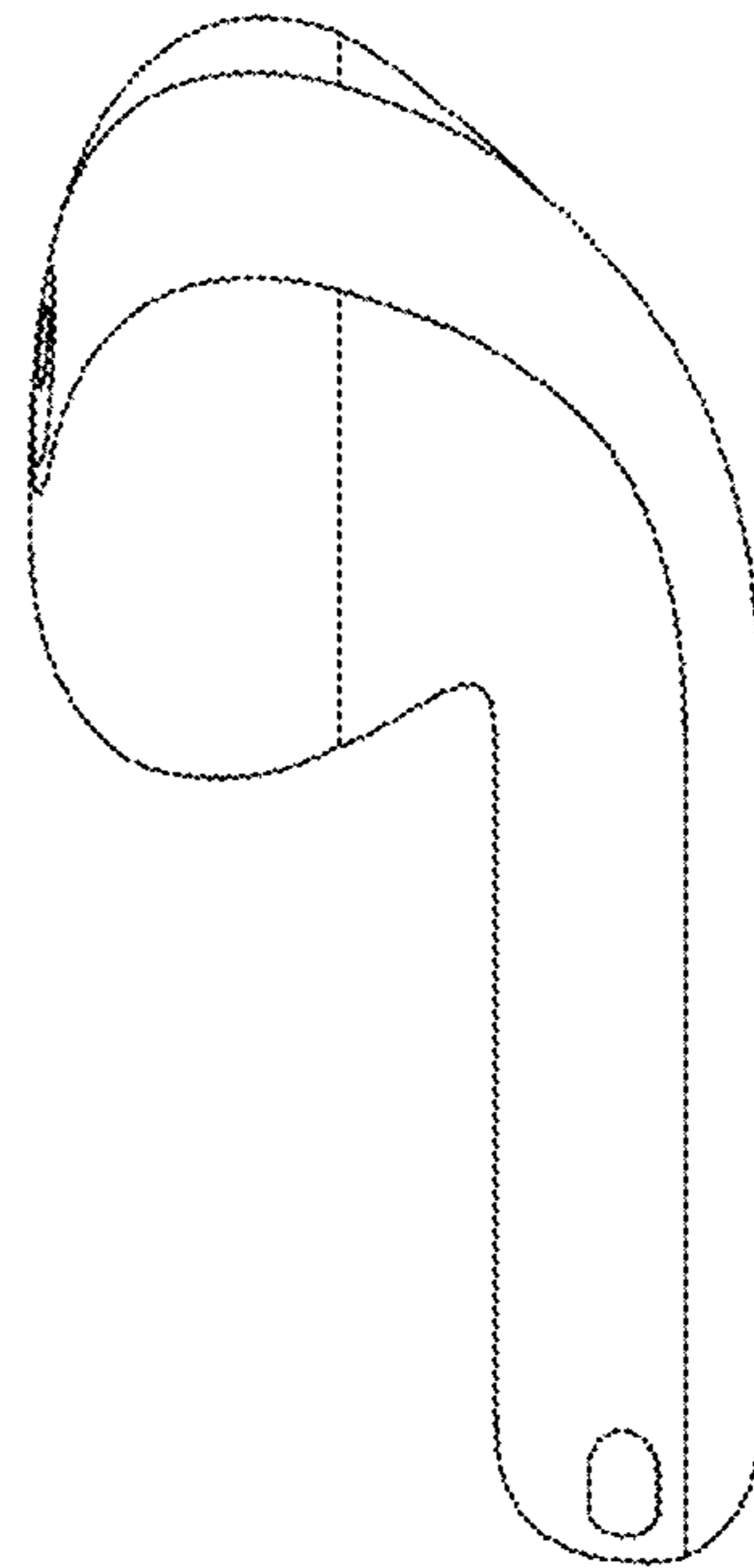
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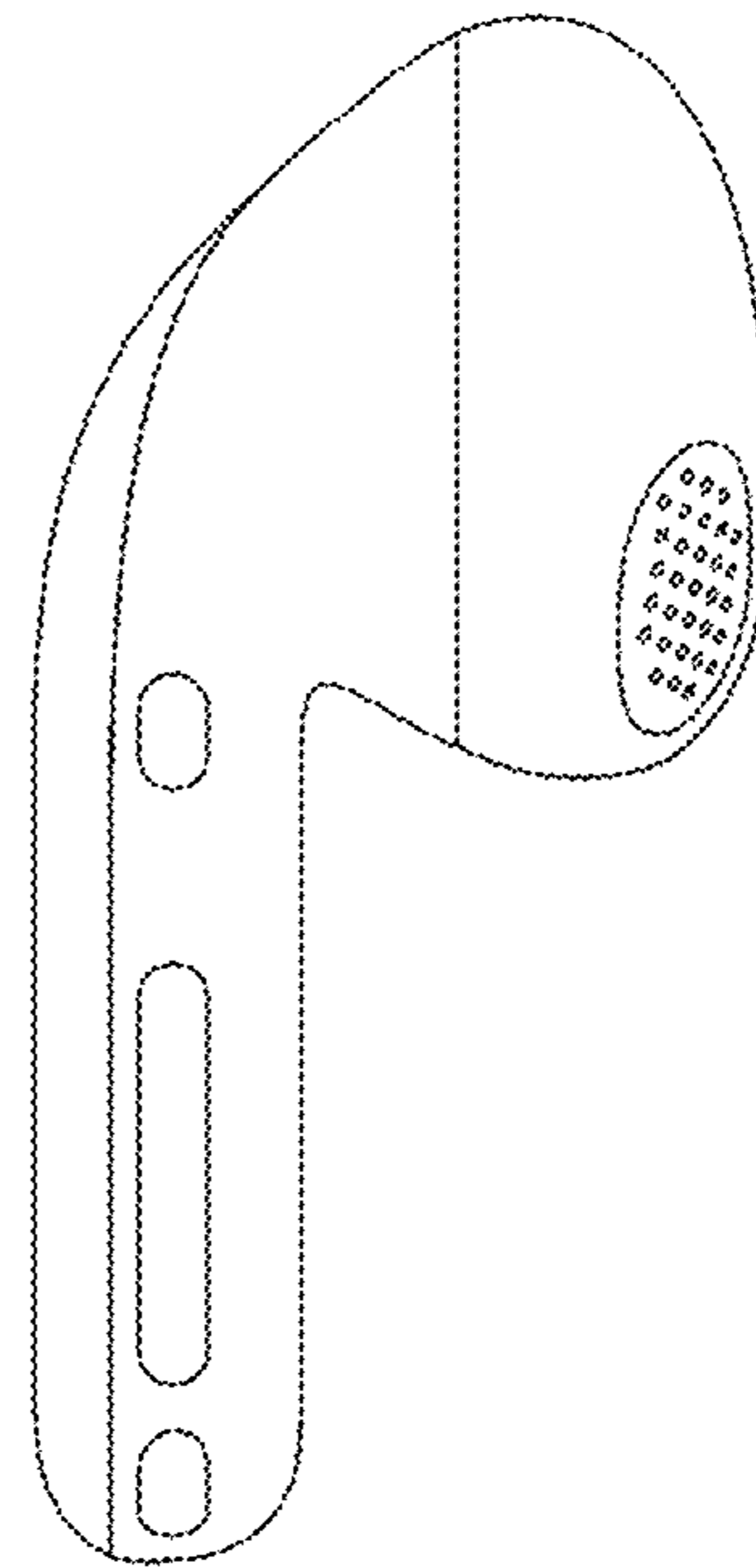
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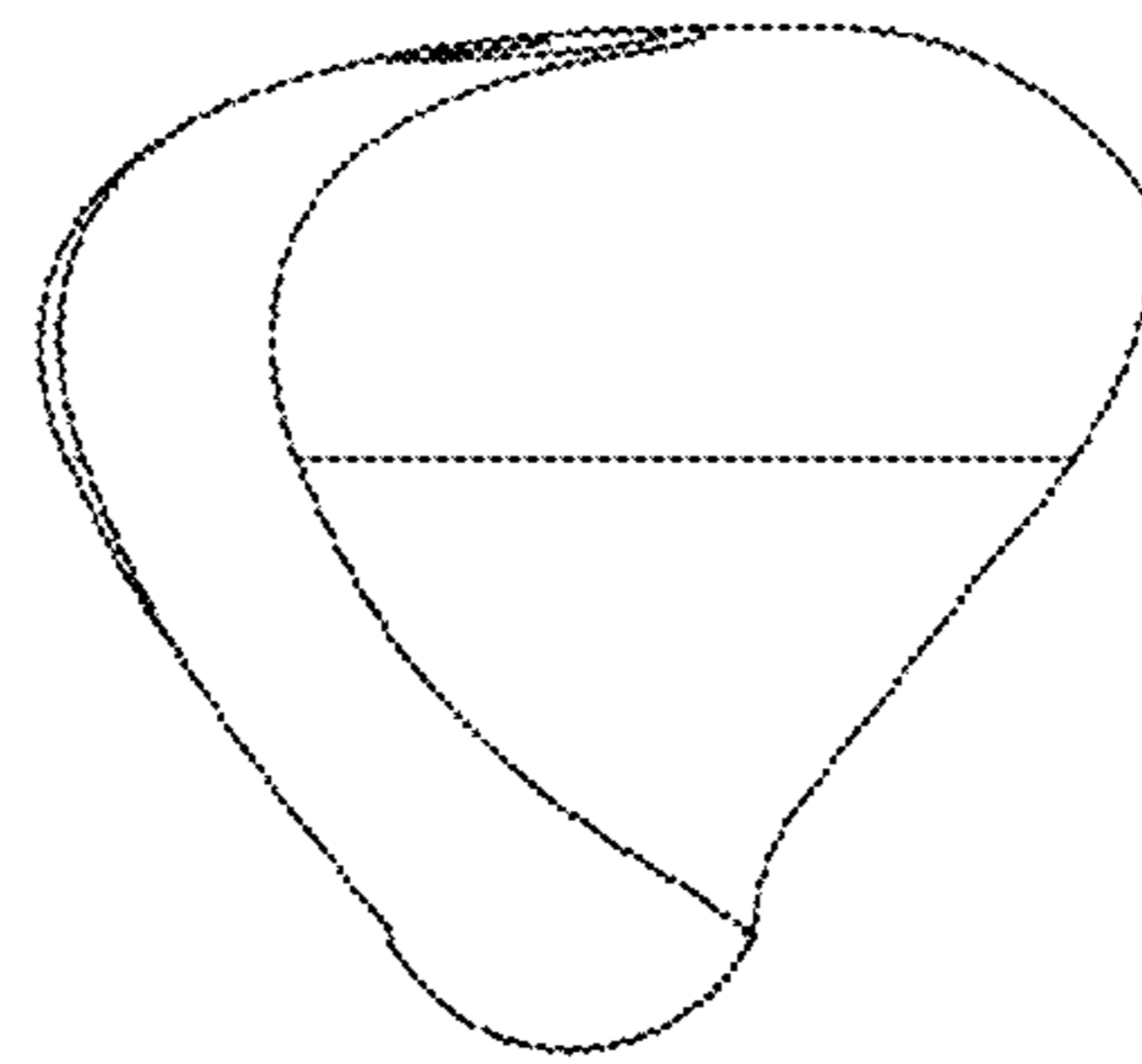
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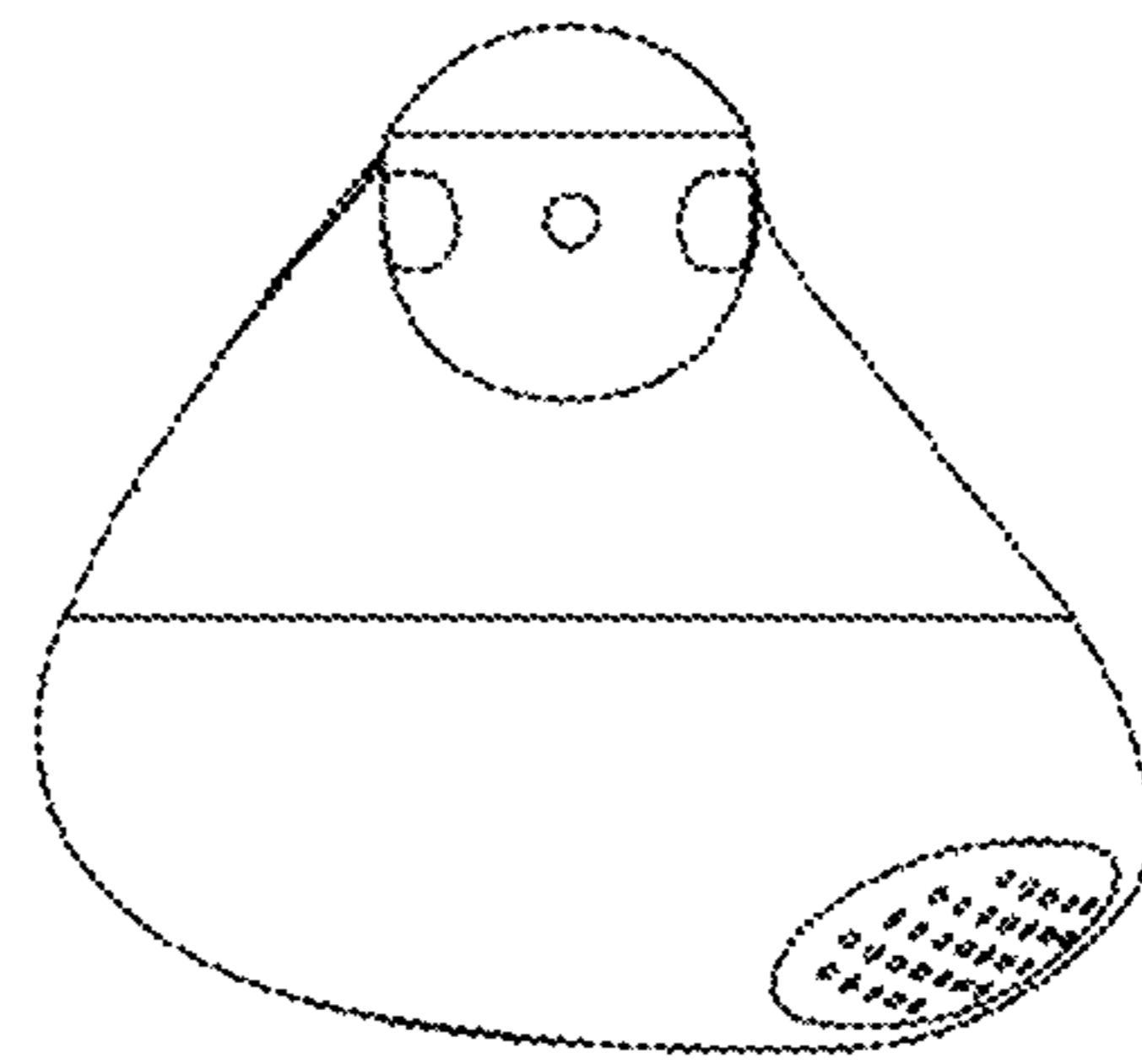
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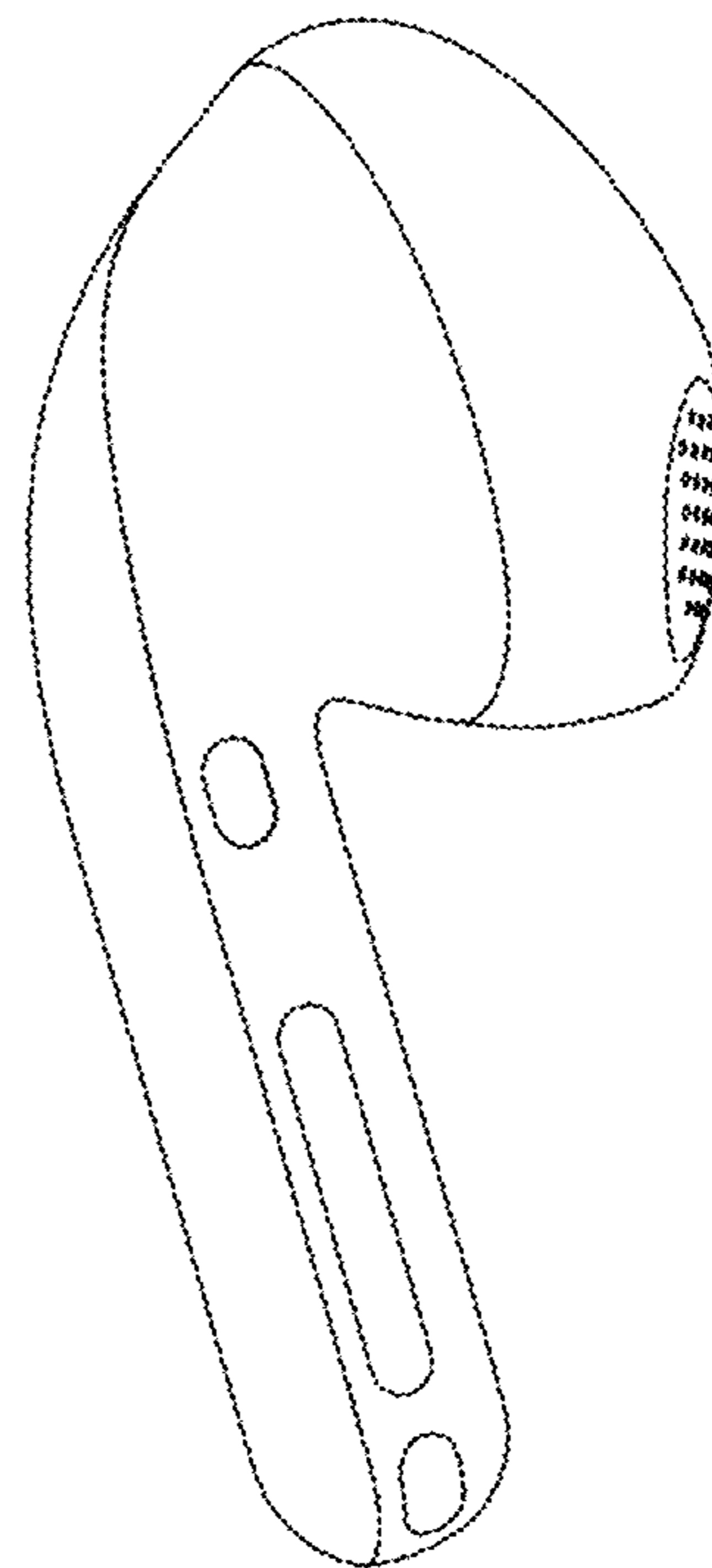
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1.6



1.7



1.8

